

BOARD LEVEL POWER SEMICONDUCTOR HEAT SINKS



262 SERIES

Horizontal and Vertical Mount Heat Sink

TO-220

Standard P/N	Height Above PC Board in. (mm)	Maximum Footprint in. (mm)	Thermal Performance at Typical Load	
			Natural Convection	Forced Convection
262-75ABE-05	.53 (13.4)	.75 (19.1) x .50 (12.78)	80°C rise @ 2W	10°C/W @ 200LFM
262-75ABE-01	.75 (19.1)	.53 (13.4) x .50 (12.7)	80°C rise @ 2W	10°C/W @ 200LFM

Material: Aluminum, Black Anodized

